

ZXTP5401G 150V, SOT223, PNP High voltage transistor

Summary

 $BV_{CEO} > -150V$ $BV_{EBO} > -5V$ $I_{C(cont)} = -600mA$ $P_D = 2W$ Complementary part number ZXTN5551G



Description

A high voltage PNP transistor in a surface mount package

Features

- 150V rating
- SOT223 package

Applications

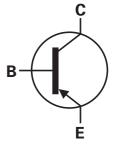
• High voltage amplification

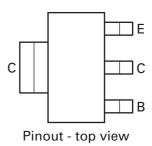
Ordering information

Device	Reel size (inches)	Tape width (mm)	Quantity per reel
ZXTP5401GTA	7	12	1000
ZXTP5401GTC	13	12	4000

Device marking

ZXTP 5401





Absolute maximum ratings

Parameter	Symbol	Limit	Unit
Collector-base voltage	V _{CBO}	-160	V
Collector-emitter voltage	V _{CEO}	-150	V
Emitter-base voltage	V _{EBO}	-5	V
Continuous collector current ^(a)	۱ _C	-600	mA
Peak collector current	۱ _C	-2	А
Power dissipation at $T_A = 25^{\circ}C^{(a)}$	P _D	2	W
Linear derating factor		16	mW/°C
Operating and storage temperature range	T _j , T _{stg}	-55 to 150	°C

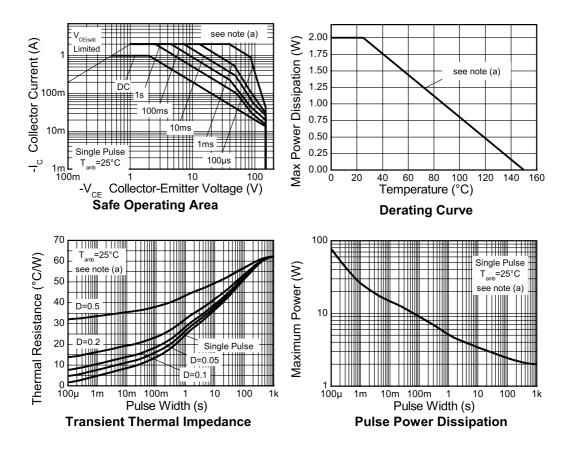
Thermal resistance

Parameter	Symbol	Limit	Unit
Junction to ambient ^(a)	R_{\ThetaJA}	62.5	°C/W

NOTES:

(a) For a device surface mounted on 50mm x 50mm x 1.6mm FR4 PCB with high coverage of single sided 1oz weight copper, in still air conditions.

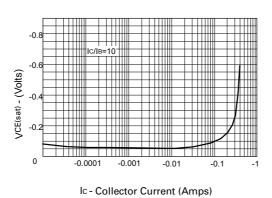
Typical characteristics



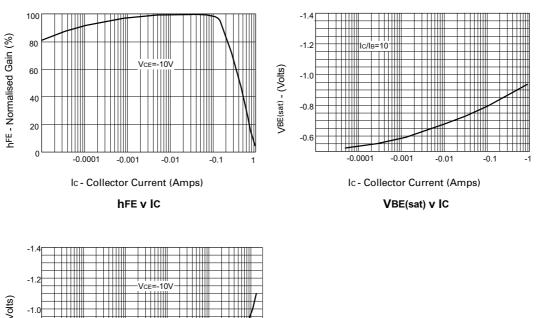
Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Collector-base breakdown voltage	BV _{CBO}	-160	-270		V	I _C = -100μA,
Collector-emitter breakdown voltage (base open)	BV _{CEO}	-150	-240		V	I _C = -1mA *
Emitter-base breakdown voltage	BV _{EBO}	-5	-8.1		V	I _E = -10μA
Collector cut-off current	I _{CBO}		<-1	-50	nA	V _{CB} = -120V
				-50	μA	$V_{CB} = -120V, T_{amb} = 100^{\circ}C$
Collector-emitter saturation	V _{CE(sat)}		-50	-200	mV	I _C = -10mA, I _B = -1mA *
voltage			-70	-500	mV	I _C = -50mA, I _B = -5mA *
Base-emitter saturation	V _{BE(sat)}		-700	-1000	mV	I _C = -10mA, I _B = -1mA *
voltage			-750	-1000	mV	I _C = -50mA, I _B = -5mA *
Static forward current transfer	h _{FE}	50	135			I _C = -1mA, V _{CE} = -5V *
ratio		60	135	240		$I_{C} = -10 \text{mA}, V_{CE} = -5 \text{V} *$
		50	130			I _C = -50mA, V _{CE} = -5V *
Transition frequency	f _T		100		MHz	I _C = -10mA, V _{CE} = -10V f = 100MHz
Output capacitance	C _{OBO}			6	pF	V _{CB} = -10V, f = 1MHz *
Delay time	t _(d)		386		ns	V _{CC} = -50V. I _C = -100mA,
Rise time	t _(r)		202		ns	I _{B1} = I _{B2} = -10mA.
Storage time	t _(s)		1720		ns	
Fall time	t _(f)		275		ns	

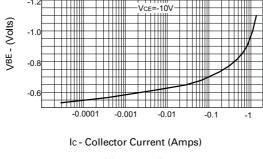
Electrical characteristics (at $T_{amb} = 25^{\circ}C$ unless otherwise stated)

Characteristics



VCE(sat) v IC

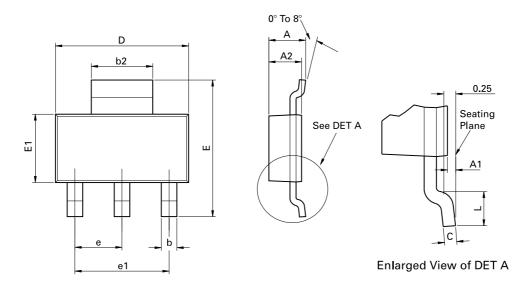






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Package outline - SOT223



Conforms to JEDEC TO-261 AA Issue B

Dim.	Millin	neters	Inc	hes	Dim.	Millimeters		Inches	
Dini.	Min.	Max.	Min.	Max.		Min.	Max.	Min.	Max.
A	-	1.80	-	0.071	D	6.30	6.70	0.248	0.264
A1	0.02	0.10	0.0008	0.004	е	2.30	BSC	0.090	5 BSC
A2	1.55	1.65	0.0610	0.0649	e1	4.60	BSC	0.181	BSC
b	0.66	0.84	0.026	0.033	E	6.70	7.30	0.264	0.287
b2	2.90	3.10	0.114	0.122	E1	3.30	3.70	0.130	0.146
С	0.23	0.33	0.009	0.013	L	0.90	-	0.355	-

Note: Controlling dimensions are in millimeters. Approximate dimensions are provided in inches

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